



SMT inductors

SIMID series, SIMID 0603-C

Series/Type: **B82496C**

Date: October 2012

SMD**Size 0603 (EIA) and/or 1608 (IEC)****Rated inductance 1 ... 220 nH****Rated current 110 ... 1800 mA****Construction**

- Copper-plated ceramic core
- Laser-cut winding, epoxy-coated

Features

- Temperature range up to +150 °C
- High resonance frequency
- Close inductance tolerance
- Free of polarization effect
- High mechanical stability
- Qualified to AEC-Q200
- Suitable for lead-free reflow soldering as referenced in JEDEC J-STD 020D
- RoHS-compatible

Applications

Resonant circuits, impedance matching for

- Multimedia
- Car access systems
- Wireless communication systems
- TPMS (Tire Pressure Monitoring System)
- GPS (Global Positioning System)
- Digital cameras

Terminals

- Base material Al₂O₃ ceramic with Cu layer
- Layer composition Ni, Sn (lead-free)
- Electro-plated

Marking

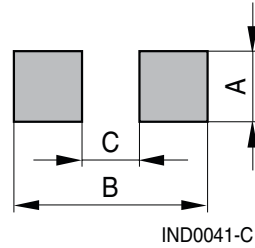
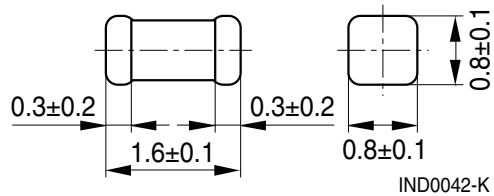
- No marking on component
- Minimum data on reel:
Manufacturer, ordering code, L value,
quantity, date of packing

Delivery mode and packing unit

- 8-mm cardboard tape, wound on 180-mm Ø reel
- Bulk case on request
- Packing unit: 4000 pcs./reel

SMD

Dimensional drawing and layout recommendation

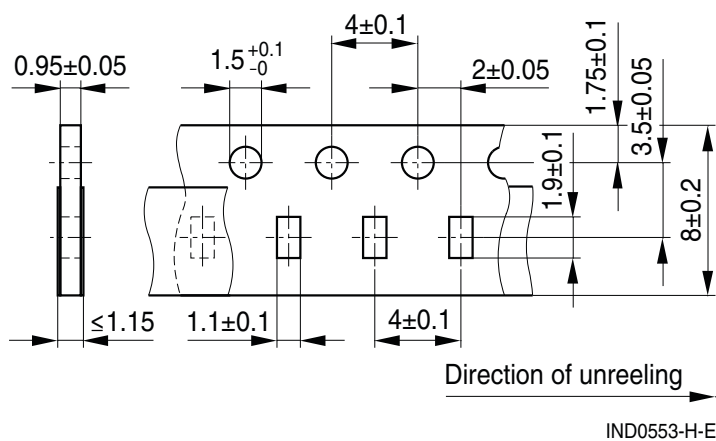


A	B	C
0.8 ± 0.1	2.3 ± 0.3	0.9 ± 0.1

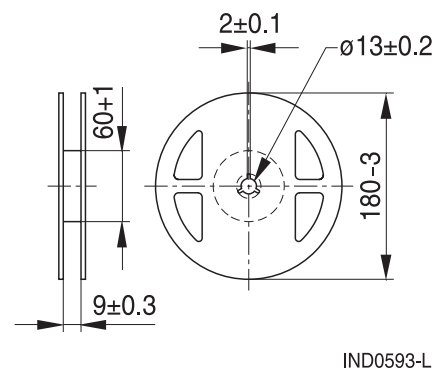
Dimensions in mm

Taping and packing

Cardboard tape



Reel



Dimensions in mm

Technical data and measuring conditions

Rated inductance L_R	Measured with impedance analyzer Agilent 4291A and test fixture Agilent 16196A at frequency f_L , 0.1 V, +20 °C
Q factor Q_{min} , Q_{typ}	Measured with impedance analyzer Agilent 4291A and test fixture Agilent 16196A, Q_{min} measured at frequency f_Q , +20 °C
Rated temperature T_R	+125 °C
Rated current I_R	Maximum permissible DC with a temperature increase of ≤ 15 K at rated temperature
Self-resonance frequency $f_{res,min}$	Measured with network analyzer Agilent 8720D, +20 °C
DC resistance R_{max}	Measured at +20 °C
Solderability (lead-free)	Sn95.5Ag3.8Cu0.7: +(245 $\pm$ 5) °C, (5 $\pm$ 0.3) s Wetting of soldering area $\geq 95\%$ (based on IEC 60068-2-58)
Resistance to soldering heat	+260 °C, 40 s (as referenced in JEDEC J-STD 020D)
Climatic category	55/150/56 (to IEC 60068-1)
Storage conditions	Mounted: -55 °C ... +150 °C Packaged: -25 °C ... +40 °C, $\leq 75\%$ RH
Weight	Approx. 4 mg

Characteristics and ordering codes

L _R nH	Tolerance	Q _{min}	Q _{typ} (at 800 MHz)	f _L ; f _Q MHz	I _R mA	R _{max} Ω	f _{res,min} GHz	Ordering code ¹⁾²⁾ (reel packing)
1.0	±0.3 nH ≙ A ±0.2 nH ≙ Z	7	60	100	1800	0.02	16	B82496C3109+000
1.2		8	60	100	1800	0.025	15	B82496C3129+000
1.5		8	50	100	1500	0.03	13	B82496C3159+000
1.8		12	50	100	1500	0.033	12	B82496C3189+000
2.2		14	50	100	1500	0.035	10	B82496C3229+000
2.7		14	40	100	1400	0.04	10	B82496C3279+000
3.3		14	40	100	1200	0.06	9	B82496C3339+000
3.9	±5% ≙ J ±0.2 nH ≙ Z	14	40	100	1100	0.065	8	B82496C3399+000
4.7		14	40	100	800	0.10	7	B82496C3479+000
5.6		14	40	100	700	0.15	6	B82496C3569+000
6.8		14	40	100	700	0.15	6	B82496C3689+000
8.2		14	40	100	650	0.18	6	B82496C3829+000
10	±5% ≙ J ±2% ≙ G	14	40	100	600	0.20	5	B82496C3100+000
12		14	40	100	450	0.35	5	B82496C3120+000
15		14	40	100	420	0.40	4.5	B82496C3150+000
18		14	40	100	400	0.45	4.0	B82496C3180+000
22		14	40	100	380	0.50	4.0	B82496C3220+000
27		14	35	100	360	0.55	3.0	B82496C3270+000
33		14	35	100	350	0.60	3.0	B82496C3330+000
39		14	35	100	300	0.80	2.5	B82496C3390+000
47		14	35	100	270	0.95	2.5	B82496C3470+000
56		14	35	100	250	1.2	2.5	B82496C3560+000
68		14	35	100	230	1.3	2.0	B82496C3680+000
82		14	35	100	220	1.5	2.0	B82496C3820+000
100		14	30	100	200	1.8	1.8	B82496C3101+000
120		5	30	25.2	160	3.0	1.8	B82496C3121+000
150		5	30	25.2	130	5.0	1.6	B82496C3151+000
180		4	25	25.2	120	6.0	1.4	B82496C3181+000
220		4	25	25.2	110	7.0	1.3	B82496C3221+000

Special versions on request.

Higher currents possible at temperatures <T_R on request.

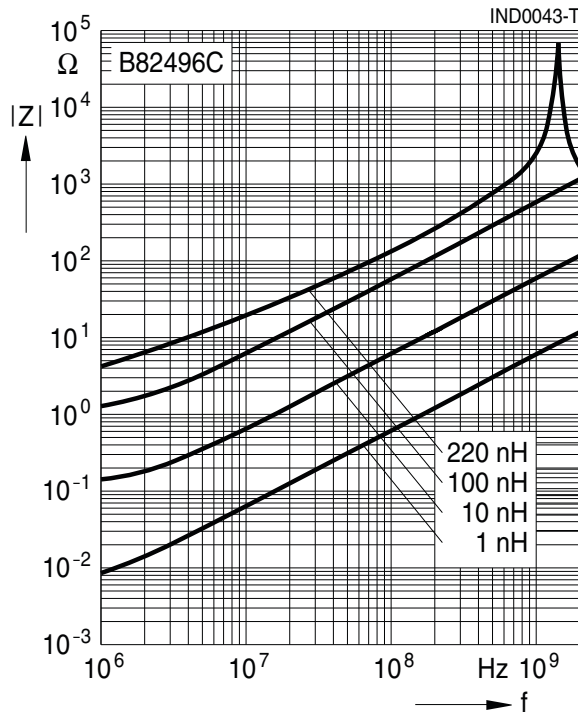
Sample kit available (see also chapter "Sample kits". Ordering code: B82496X001

1) Replace the + by the code letter for the required inductance tolerance.

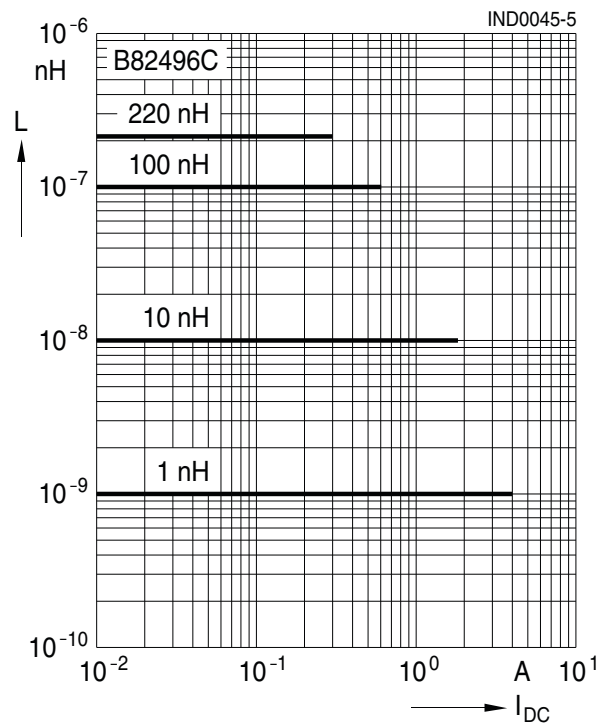
2) For bulk case the last digit has to be a »1«. Example: B82496C3109A001

SMD

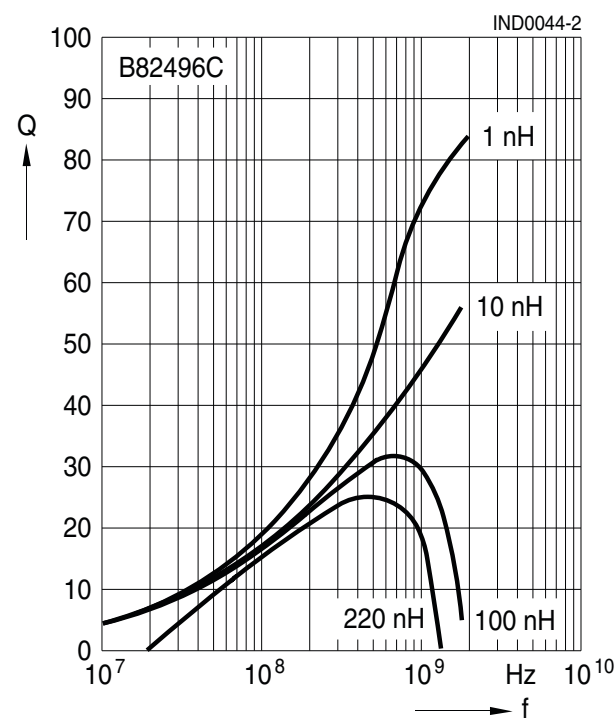
Impedance $|Z|$ versus frequency f
measured with impedance analyzer
Agilent 4291A/16196A, typical values at +20 °C



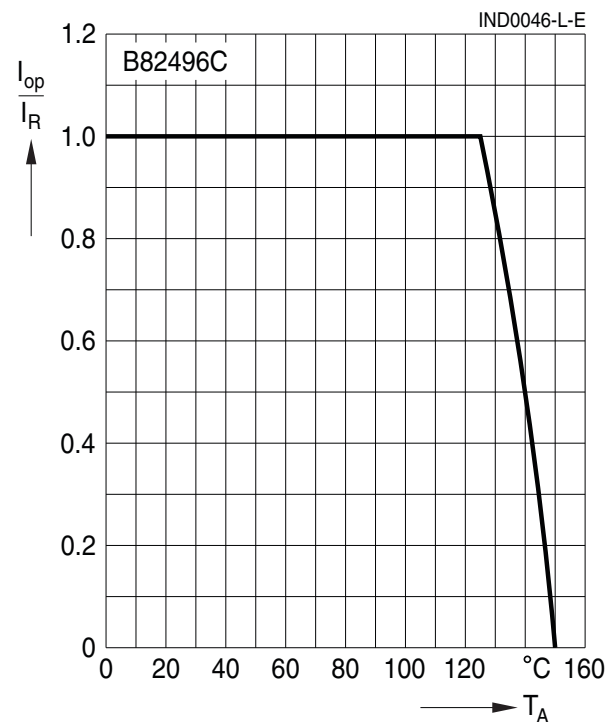
Inductance L versus DC load current I_{DC}
measured with LCR meter Agilent 4275A,
typical values at +20 °C



Q factor versus frequency f
measured with impedance analyzer
Agilent 4291A/16196A, typical values at +20 °C



Current derating I_{op}/I_R
versus ambient temperature T_A
(rated temperature $T_R = +125$ °C)



Cautions and warnings

- Please note the recommendations in our Inductors data book (latest edition) and in the data sheets.
 - Particular attention should be paid to the derating curves given there.
 - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pin, not the housing.
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. In particular, it is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.

Washing processes may damage the product due to the possible static or cyclic mechanical loads (e.g. ultrasonic cleaning). They may cause cracks to develop on the product and its parts, which might lead to reduced reliability or lifetime.
- The following points must be observed if the components are potted in customer applications:
 - Many potting materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
 - It is necessary to check whether the potting material used attacks or destroys the wire insulation, plastics or glue.
 - The effect of the potting material can change the high-frequency behaviour of the components.
- Ferrites are sensitive to direct impact. This can cause the core material to flake, or lead to breakage of the core.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.

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